

SURFACE MOUNT

GLASS PASSIVATED SILICON RECTIFIER
VOLTAGE RANGE 50 to 1000 Volts CURRENT 1.0 Ampere

FEATURES

- * Glass passivated device
- * Ideal for surface mounted applications
- * Low leakage current
- * Metallurgically bonded construction
- * Mounting position: Any
- * Weight: 0.057 gram
- * P/N suffix V means AEC-Q101 qualified, e.g:FM4001V
- * P/N suffix V means Halogen-free

MECHANICAL DATA

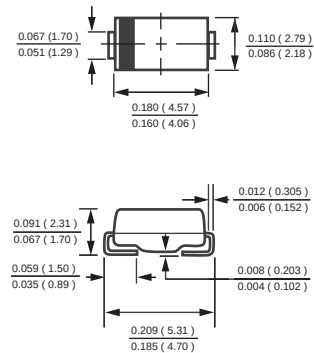
- * Epoxy : Device has UL flammability classification 94V-0

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.
resistive or inductive load.



DO-214AC



MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS	SYMBOL	FM4001	FM4002	FM4003	FM4004	FM4005	FM4006	FM4007	UNITS
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at Ambient Temperature	I _O	1.0							Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	30							Amps
Current Squarad Time	i ² t	3.7							A ² /Sec
Typical Thermal Resistance (Note 1)	R _{θJA}	80							°C/W
Typical Thermal Resistance (Note 1)	R _{θJL}	27					30		°C/W
Typical Junction Capacitance (Note 2)	C _J	15							pF
Operating Temperature Range	T _J	-55 to + 175							°C
Storage Temperature Range	T _{STG}	-55 to + 175							°C

ELECTRICAL CHARACTERISTICS(@TA=25 °C unless otherwise noted)

CHARACTERISTICS	SYMBOL	FM4001	FM4002	FM4003	FM4004	FM4005	FM4006	FM4007	UNITS
Maximum Instantaneous Forward Voltage at 1.0A DC	V_F	1.0							Volts
Maximum Average Reverse Current	I_R	0.5							uA
at Rated DC Blocking Voltage		100							uA

NOTES : 1. Thermal Resistance :Mounted on PCB.
2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.

2018-10
REV:F

RATING AND CHARACTERISTICS CURVES (FM4001 THRU FM4007)

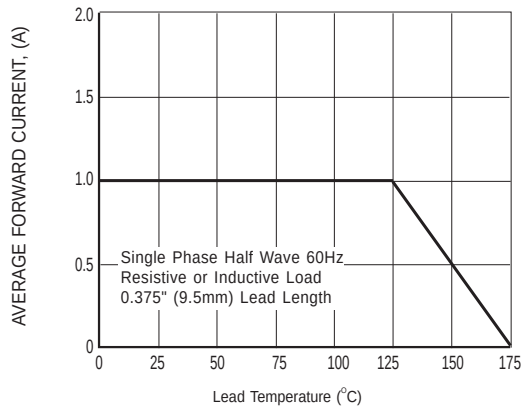


FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

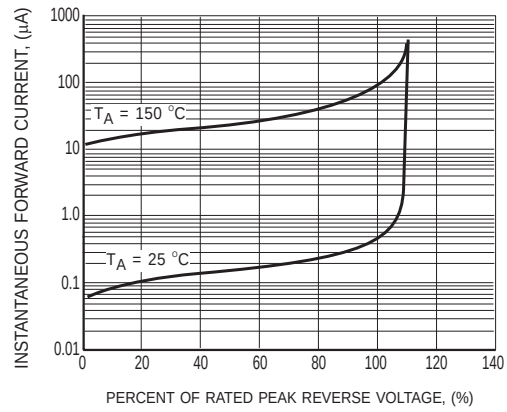


FIG.2 MAXIMUM REVERSE CHARACTERISTICS

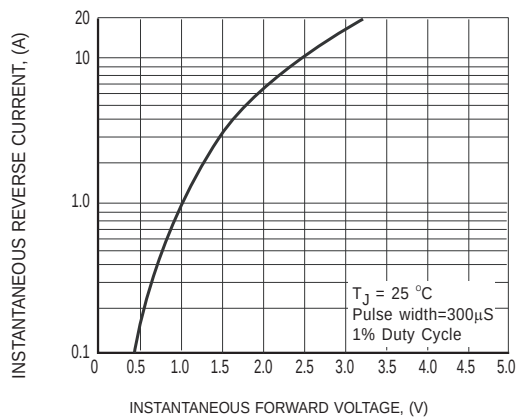


FIG.3 MAXIMUM INSTANTANEOUS FORWARD CHARACTERISTICS

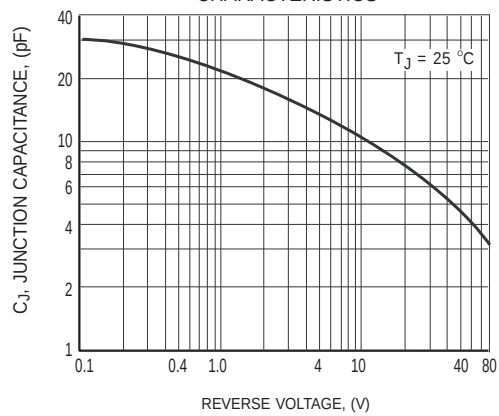


FIG.4 TYPICAL JUNCTION CAPACITANCE

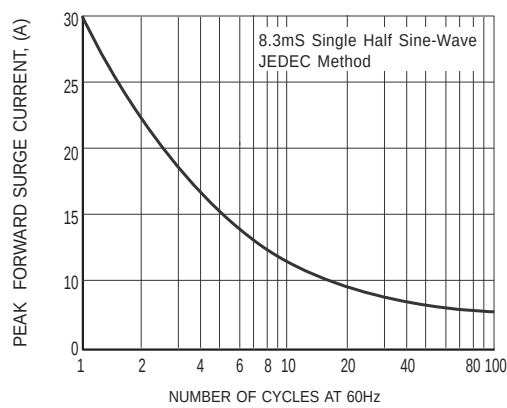
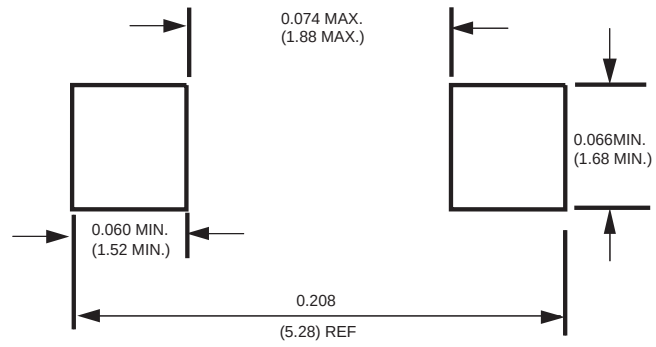


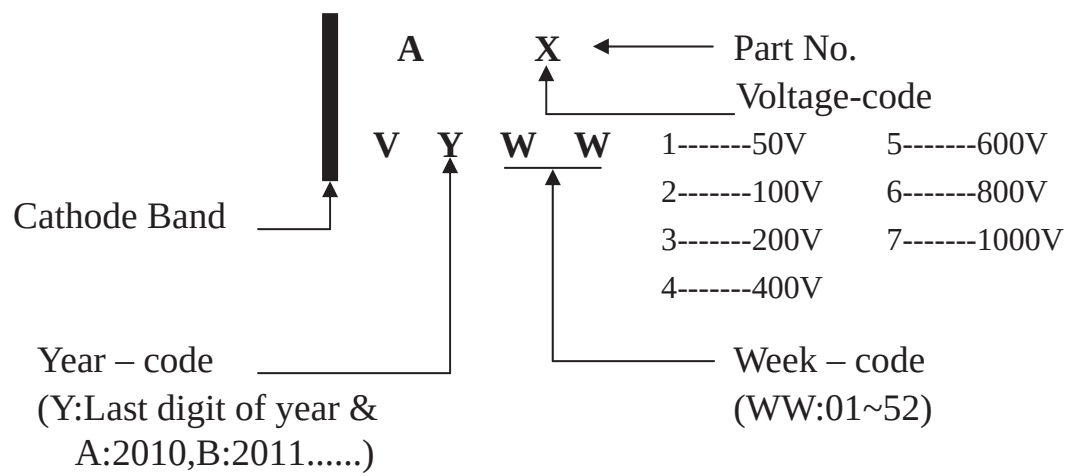
FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

Mounting Pad Layout



Dimensions in inches and (millimeters)

Marking Description



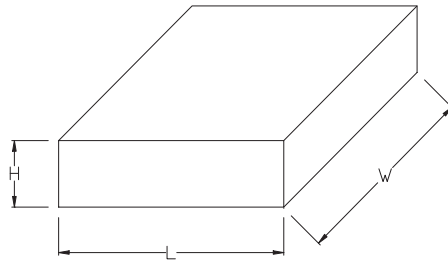
PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMA	-W	7,500	15,000	---	---	330	360*355*360	120,000	15.2

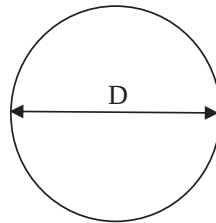
PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMA	-T	2,000	8,000	---	---	178	390*205*310	64,000	7.8

1. BOX



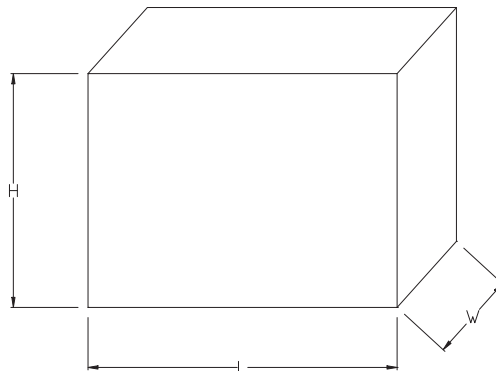
Packing Code	L (mm)	W (mm)	H (mm)
-T	182	182	68
-W	338	338	40

2. REEL



Packing Code	D (mm)
-T	178
-W	330

3. CARTON



Packing Code	L (mm)	W (mm)	H (mm)
-T	390	205	310
-W	360	355	360

REEL TAPING SPECIFICATIONS FOR SURFACE MOUNT DEVICES-FLAT MELF (SMA/SMB/SMC)

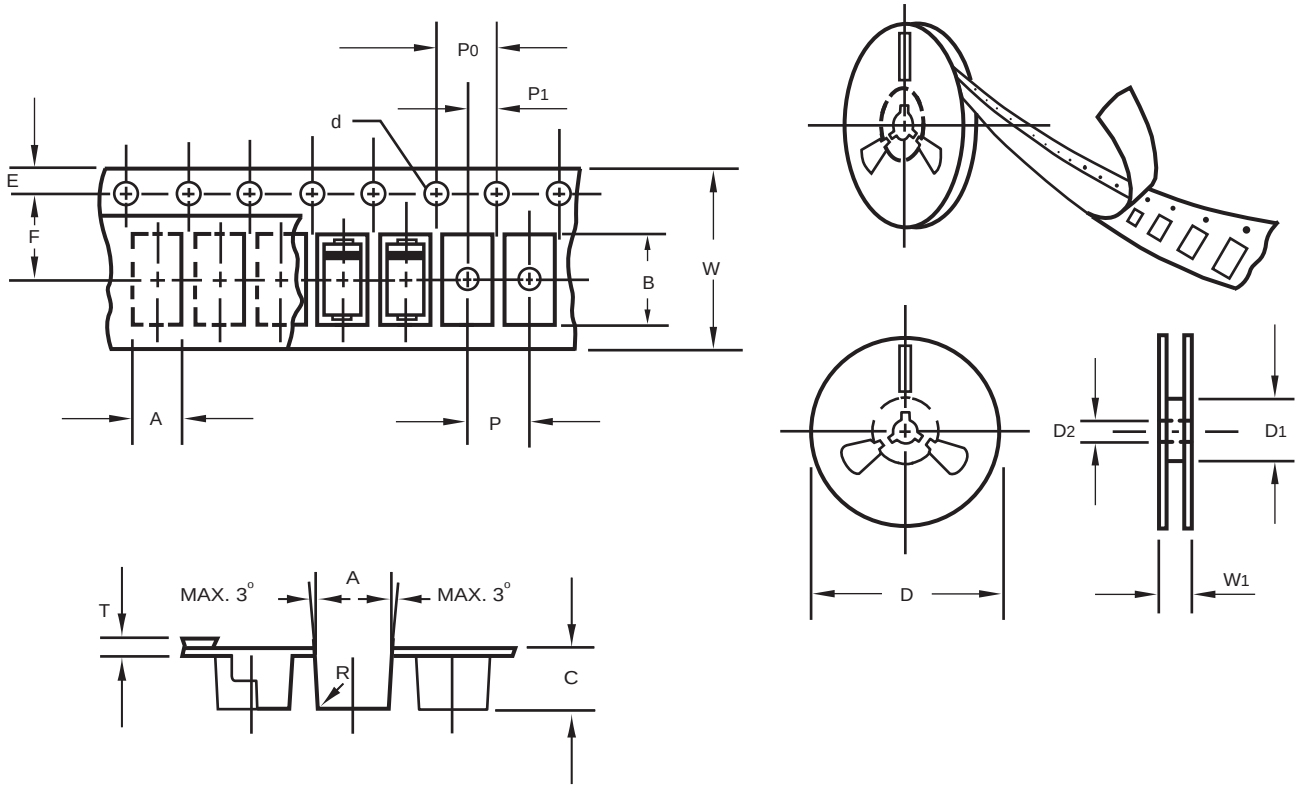


Fig.: Configuration of FLAT MELF TAPING
(SMA/SMB/SMC)

ITEM	SYMBOL	DO214AC (SMA) mm(inch)	DO214AA (SMB) mm(inch)	DO214AB (SMC) mm(inch)
Carrier width	A	2.6 ± 0.15 (0.102 ± 0.006)	3.65 ± 0.1 (0.144 ± 0.004)	6.0 ± 0.1 (0.236 ± 0.004)
Carrier length	B	5.15 ± 0.15 (0.203 ± 0.006)	5.69 ± 0.1 (0.224 ± 0.004)	8.30 ± 0.1 (0.327 ± 0.004)
Carrier depth	C	2.3 ± 0.15 (0.091 ± 0.006)	2.67 ± 0.1 (0.105 ± 0.004)	2.5 ± 0.1 (0.098 ± 0.004)
Sprocket hole	d	1.5 ± 0.1 (0.059 ± 0.004)	1.5 ± 0.1 (0.059 ± 0.004)	1.5 ± 0.1 (0.059 ± 0.004)
Reel outside diameter	D	178 ± 2.0 (7.0 ± 0.079)	178 ± 2.0 (7.0 ± 0.079)	178 ± 2.0 (7.0 ± 0.079)
Reel inner diameter	D1	50 Min.	50 Min.	50 Min.
Feed hole diameter	D2	13 ± 0.5 (0.512 ± 0.020)	13 ± 0.5 (0.512 ± 0.020)	13 ± 0.5 (0.512 ± 0.020)
Strocket hole position	E	1.5 ± 0.1 (0.059 ± 0.004)	1.5 ± 0.1 (0.059 ± 0.004)	1.5 ± 0.1 (0.059 ± 0.004)
Punch hole position	F	5.65 ± 0.05 (0.222 ± 0.002)	5.65 ± 0.05 (0.222 ± 0.002)	7.65 ± 0.05 (0.301 ± 0.002)
Punch hole pitch	P	4.0 ± 0.1 (0.157 ± 0.004)	8.0 ± 0.1 (0.315 ± 0.004)	8.0 ± 0.1 (0.315 ± 0.004)
Sprocket hole pitch	P0	4.0 ± 0.1 (0.157 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)
Embossment center	P1	2.0 ± 0.1 (0.079 ± 0.004)	2.0 ± 0.1 (0.079 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)
Total tape thickness	T	0.30 ± 0.05 (0.012 ± 0.002)	0.6 Max.	0.6 Max.
Tape width	W	12.0 ± 0.2 (0.472 ± 0.008)	12.0 ± 0.2 (0.472 ± 0.008)	16.0 ± 0.2 (0.630 ± 0.008)
Reel width	W1	16.8 ± 2.0 (0.661 ± 0.079)	16.8 ± 2.0 (0.661 ± 0.079)	24.0 ± 2.0 (0.945 ± 0.079)

Note: 1.Devices are packed in accordance with EIA standard RS-481-A and specification given above.
2.Available on 7 inch (1500 ct.) or 13 inch (5000 ct.) diameter reels.

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